ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® INTERNATIONAL AND PARTICLE	C, Bannockt	ourn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar he declaratio	ration of the n encompa	e substances sses all lowe	within the m r level mater	anufacturer ials for whic	listed iten ch the mar	n. Note: if ufacturer l	the item is an as	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					s and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Response Date*						
onsemi												2024-04-20			
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product Enviro Compliance			NA				]	Product-Env-Stewards@onsemi.com						
Authorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				F	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				]	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item	n Number	r Mfr Item Name			Effective Da	ate Versi	Version Manufacturing Site		ig Site	We	ight*	UOM	Unit Type	
	FAN210	6EMPX	6A 24V Buck Regulator			2024-04-20			TH6		68.	845	mg	Each	
Manufacturing Proccess Informat	ion						1						-	I	
Terminal Plating / Grid Array Ma	erial 7	Terminal Base A	Alloy	J-STD-020 MSL Rati		Peak Process Body Temper		y Temperatu	ture Max Time at Peak Temp		emperature	are Number of Reflow Cycles		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30 seco		seconds	conds 3			
Comments															
evel 1 - maximum time at peak temperatu	e during so	ldering is 10-3	0 seconds												
or more information regarding material o	omposition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	toHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.74	mg	Supplier	Silicon (Si)	7440-21-3		2.74	mg
Die Attach	0.518	mg	Supplier	Silver (Ag)	7440-22-4		0.4921	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0259	mg
Lead Frame	23.905	mg	Supplier	Zinc (Zn)	7440-66-6		0.048	mg
			Supplier	Iron (Fe)	7439-89-6		0.621	mg
			Supplier	Copper (Cu)	7440-50-8		23.2	mg
			Supplier	Phosphorus (P)	7723-14-0		0.036	mg
Mold Compound-Black	40.9	mg		Metal Hydroxide	proprietary data		1.4315	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.272	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2045	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		32.72	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.272	mg
Plating	0.233	mg	Supplier	Palladium (Pd)	7440-05-3		0.021	mg
			В	Nickel (Ni)	7440-02-0		0.209	mg
			Supplier	Gold (Au)	7440-57-5		0.003	mg
Wire Bond - Au	0.296	mg	Supplier	Gold (Au)	7440-57-5		0.296	mg
Wire Bond - Cu	0.253	mg	Supplier	Palladium (Pd)	7440-05-3		0.0051	mg
			Supplier	Copper (Cu)	7440-50-8		0.2479	mg